

12-18-2003

Alexandria, VA 22313

Form PTO-1595

F

(Rev. 03/01)



U.S. DEPARTMENT OF COMMERCE

U.S. PATENT AND TRADEMARK OFFICE

To the honorable Commissioner of F

102626086

and original document or copy thereof:

1. Name of Conveying Party(ies):

LEE, JOON HYEON

12.10-03

2. Name and Address of Receiving Party(ies):

Name: Hynix Semiconductor Inc.

Street Address: San 136-1, Ami-Ri, Bubal-Uep

Street Address:

City: Ichon-Shi, Kyungki-Do

State/Country: Korea

Postal Code: 467-860

Additional name(s) of conveying party(ies) attached?

☐

Yes

☒

No

Additional name(s) and addresses attached?

☐

Yes

☒

No

3. Nature of Conveyance:

☒ Assignment☐ Change of Name☐ Security Agreement☐ Other:☐ Merger

Execution Date: 11012003

4. Application Number(s) or Patent Number(s):

10731482

☒ Assignment is being filed together with new application and the first execution date of application is : 12102003☐ Application has been filed already and the application filing date is:

A. Patent Application Number(s):

B. Issued Patent Number(s):

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning this matter should be mailed:

CUSTOMER NUMBER 00136 -or-

JACOBSON HOLMAN PLLC

400 Seventh Street, N.W.

Washington, D.C. 20004-2218

Tel. 202-638-6666

Attorney Docket Number: P69372US0

6. Total number of applications and patents involved:

1

7. Total Fee (37 CFR 3.41): \$ 40.00

☒ Enclosed☒ Any deficiencies in enclosed fees are authorized to be charged to Deposit Account No. 06-1358.

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8. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Yoon S. Ham/45,307

December 10, 2003

Name of Person Signing, Reg. No.

Signature

Date

12/17/2003 LIMELLER 00000258 061358 10731482

Total number of pages including cover sheet, attachments, and documents:

-2-

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22388 U.S. PTO
10731482

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UNITED STATES OF AMERICA - ASSIGNMENT

(1-5)	Insert <u>Name(s) of Inventor(s)</u>	(1)	Joon Hyeon LEE	
		(2)		
		(3)		
		(4)		
		(5)		
			In consideration of the sum of one dollar (\$1.00), and other good and valuable considerations paid to each of the undersigned, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assigns, transfers and sets over to	
(6)	Insert <u>Name of Assignee</u>	(6)	Hynix Semiconductor Inc.	
(7)	Insert <u>Address of Assignee</u>	(7)	of	San 136-1, Ami-Ri, Bubal-Uep, Ichon-Shi, Kyungki-Do 467-860, Republic of Korea
(8)	Insert <u>Legal Entity and State or Country (e.g., a corporation or citizen of Korea)</u>	(8)	A(n)	Corporation of Republic of Korea
			(hereinafter designated as the Assignee) the entire right, title and interest for the United States, its territories, dependencies and possessions, in the invention known as	
(9)	Insert <u>Identification of Invention, such as Title, Case Number or Foreign Application Number</u>	(9)	METHOD OF FORMING METAL LINE LAYER IN SEMICONDUCTOR DEVICE	
(10)	Insert <u>Date of signing of Application, or filing date and Serial No., if known</u>	(10)	for which the undersigned has (have) executed an application for patent in the United States of Said application having been executed/filed on December 10, 2003 (and assigned Serial No. New Application)	

1) The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing or divisional and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this or any continuing or divisional applications thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims provisions of the International Union for Protection of Industrial Property or similar agreements.

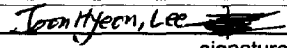
4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents United States resulting from this application or any continuing or divisional applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute any agreement in conflict herewith.

6) Assignor hereby further assigns to Assignee all claims and causes of action for infringement of the patent rights assigned herein, right to sue for, and collect damages for, any and all acts of past and future infringement.

7) The undersigned hereby grant(s) the law firm of Jacobson Holman PLLC, 400 Seventh Street, N.W., Washington, D.C. 20004, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date	November 1, 2003	Name of Inventor	Joon Hyeon LEE	 Typed name signature	(SEAL)
Date		Name of Inventor		Typed name signature	(SEAL)
Date		Name of Inventor		Typed name signature	(SEAL)
Date		Name of Inventor		Typed name signature	(SEAL)
Date		Name of Inventor		Typed name signature	(SEAL)
Date		Name of Inventor		Typed name signature	(SEAL)

This assignment should preferably be signed before a United States Consul if signed abroad, or a Notary Public if domestically signed. If not, then the execution by the inventor(s) should be witnessed by at least two witnesses who sign here:

<input type="checkbox"/> Additional inventor's names and signatures on a separate sheet.	Witness	Jin Seok KIM
	Witness	Jung Ho PARK

LAW OFFICES OF
JACOBSON HOLMAN
 PROFESSIONAL LIMITED LIABILITY COMPANY
 THE JENIFER BUILDING
 400 SEVENTH STREET, N.W.
 WASHINGTON, D.C. 20004

JH 5/01 (Copying without deletions permitted)